Product data sheet

1. General description

The 74LVC08A provides four 2-input AND gates.

Inputs can be driven from either 3.3 V or 5 V devices. This feature allows the use of these devices as translators in mixed 3.3 V and 5 V applications.

2. Features and benefits

- 5 V tolerant inputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

3. Ordering information

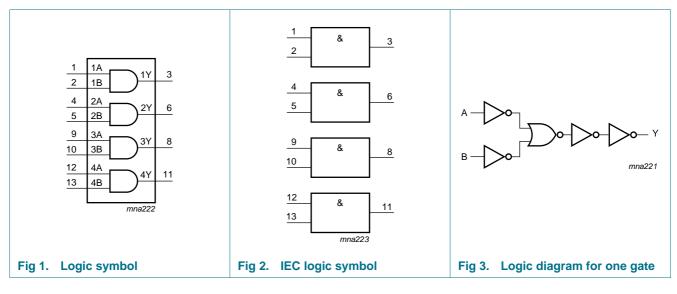
Table 1.Ordering information

| Type number | Package | | | | | | | |
|-------------|-------------------|----------|--|----------|--|--|--|--|
| | Temperature range | Name | Description | Version | | | | |
| 74LVC08AD | –40 °C to +125 °C | SO14 | plastic small outline package; 14 leads; body width 3.9 mm | SOT108-1 | | | | |
| 74LVC08ADB | –40 °C to +125 °C | SSOP14 | plastic shrink small outline package; 14 leads; body width 5.3 mm | SOT337-1 | | | | |
| 74LVC08APW | –40 °C to +125 °C | TSSOP14 | plastic thin shrink small outline package; 14 leads; body width 4.4 mm | SOT402-1 | | | | |
| 74LVC08ABQ | –40 °C to +125 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body $2.5 \times 3 \times 0.85$ mm | SOT762-1 | | | | |



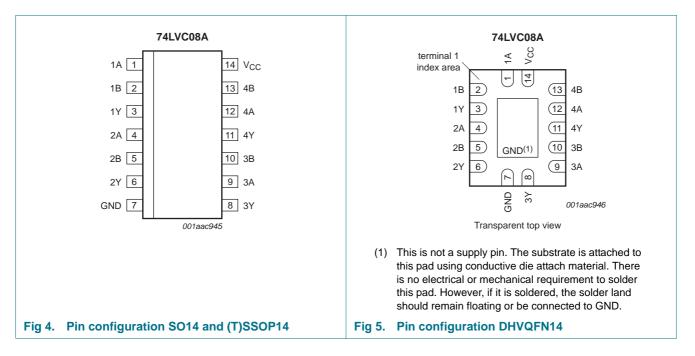
Quad 2-input AND gate

4. Functional diagram



5. Pinning information

5.1 Pinning



5.2 Pin description

| Table 2. | Pin description | |
|-----------------|-----------------|----------------|
| Symbol | Pin | Description |
| 1A to 4A | 1, 4, 9, 12 | data output |
| 1B to 4B | 2, 5, 10, 13 | data input |
| 1Y to 4Y | 3, 6, 8,11 | data input |
| GND | 7 | ground (0 V) |
| V _{CC} | 14 | supply voltage |

6. Functional description

Table 3. Function selection^[1]

| Input | | Output |
|-------|----|--------|
| nA | nB | nY |
| L | X | L |
| X | L | L |
| Н | Н | Н |

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|--|-----------------|----------------|------|
| V _{CC} | supply voltage | | -0.5 | +6.5 | V |
| I _{IK} | input clamping current | V _I < 0 V | -50 | - | mA |
| VI | input voltage | | <u>[1]</u> –0.5 | +6.5 | V |
| I _{OK} | output clamping current | $V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0 V | - | ±50 | mA |
| Vo | output voltage | output HIGH or LOW-state | [2] -0.5 | $V_{CC} + 0.5$ | V |
| lo | output current | $V_{O} = 0 V$ to V_{CC} | - | ±50 | mA |
| I _{CC} | supply current | | - | 100 | mA |
| I _{GND} | ground current | | -100 | - | mA |
| P _{tot} | total power dissipation | $T_{amb} = -40 \ ^{\circ}C \text{ to } +125 \ ^{\circ}C$ | [3] _ | 500 | mW |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| | | | | | |

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO14 packages: above 70 °C derate linearly with 8 mW/K.
 For (T)SSOP14 packages: above 60 °C derate linearly with 5.5 mW/K.
 For DHVQFN14 packages: above 60 °C derate linearly with 4.5 mW/K.

Quad 2-input AND gate

Recommended operating conditions 8.

| Table 5. | Recommended operating conc | litions | | | | |
|-----------------------|-------------------------------------|--|------|-----|-----------------|------|
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
| V _{CC} | supply voltage | | 1.65 | - | 3.6 | V |
| | | functional | 1.2 | - | - | V |
| VI | input voltage | | 0 | - | 5.5 | V |
| Vo | output voltage | output HIGH or LOW-state | 0 | - | V _{CC} | V |
| T _{amb} | ambient temperature | | -40 | - | +125 | °C |
| $\Delta t / \Delta V$ | input transition rise and fall rate | V_{CC} = 1.65 V to 2.7 V | 0 | - | 20 | ns/V |
| | | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | 0 | - | 10 | ns/V |
| | | | | | | |

Static characteristics 9.

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | -40 | –40 °C to +85 °C | | | –40 °C to +125 °C | | |
|-----------------|--------------------------|--|-----------------------|----------------------|----------------------|----------------------|----------------------|----|--|
| | | | Min | Typ <mark>[1]</mark> | Max | Min | Max | | |
| VIH | HIGH-level | V _{CC} = 1.2 V | 1.08 | - | - | 1.08 | - | V | |
| | input voltage | V_{CC} = 1.65 V to 1.95 V | $0.65\ \times V_{CC}$ | - | - | $0.65 \times V_{CC}$ | - | V | |
| | | V_{CC} = 2.3 V to 2.7 V | 1.7 | - | - | 1.7 | - | V | |
| | | $V_{CC} = 2.7 V \text{ to } 3.6 V$ | 2.0 | - | - | 2.0 | - | V | |
| V _{IL} | LOW-level | V _{CC} = 1.2 V | - | - | 0.12 | - | 0.12 | V | |
| | input voltage | V_{CC} = 1.65 V to 1.95 V | - | - | $0.35 \times V_{CC}$ | - | $0.35 \times V_{CC}$ | V | |
| | | V_{CC} = 2.3 V to 2.7 V | - | - | 0.7 | - | 0.7 | V | |
| | | V_{CC} = 2.7 V to 3.6 V | - | - | 0.8 | - | 0.8 | V | |
| V _{OH} | HIGH-level | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | | | | |
| | output voltage | $I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$ | $V_{CC}-0.2$ | - | - | $V_{CC}-0.3$ | - | V | |
| | | $I_0 = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$ | 1.2 | - | - | 1.05 | - | V | |
| | | $I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$ | 1.8 | - | - | 1.65 | - | V | |
| | | $I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | 2.2 | - | - | 2.05 | - | V | |
| | | $I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.4 | - | - | 2.25 | - | V | |
| | | $I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | 2.2 | - | - | 2.0 | - | V | |
| V _{OL} | LOW-level | $V_{I} = V_{IH} \text{ or } V_{IL}$ | | | | | | | |
| | output voltage | $I_{O} = 100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$ | - | - | 0.2 | - | 0.3 | V | |
| | | I _O = 4 mA; V _{CC} = 1.65 V | - | - | 0.45 | - | 0.65 | V | |
| | | I_0 = 8 mA; V_{CC} = 2.3 V | - | - | 0.6 | - | 0.8 | V | |
| | | I_0 = 12 mA; V_{CC} = 2.7 V | - | - | 0.4 | - | 0.6 | V | |
| | | $I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$ | - | - | 0.55 | - | 0.8 | V | |
| lı | input leakage current | V_{CC} = 3.6 V; V_{I} = 5.5 V or GND | - | ±0.1 | ±5 | - | ±20 | μA | |

Product data sheet

Quad 2-input AND gate

| Symbol | Parameter | Conditions | -4 | –40 °C to +85 °C | | | –40 °C to +125 °C | | |
|------------------|---------------------------------|--|-----|------------------|-----|-----|-------------------|----|--|
| | | | Min | Typ[1] | Max | Min | Max | | |
| I _{CC} | supply current | V_{CC} = 3.6 V; V_I = V_{CC} or GND; I_O = 0 A | - | 0.1 | 10 | - | 40 | μA | |
| ∆I _{CC} | additional supply current | per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_I = V_{CC} - 0.6 V; I_O = 0 A$ | - | 5 | 500 | - | 5000 | μA | |
| CI | input capacitance | $V_{CC} = 0 V \text{ to } 3.6 V;$ $V_I = GND \text{ to } V_{CC}$ | - | 4.0 | - | - | - | pF | |

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V)

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7.Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 7.

| Symbol | Parameter | Conditions | Conditions | | °C to +8 | 5 °C | –40 °C to +125 °C | | Unit |
|--------------------|-------------------|--|------------|-----|----------------------|------|-------------------|------|------|
| | | | | Min | Typ <mark>[1]</mark> | Max | Min | Max | |
| t _{pd} | propagation delay | nA, nB to nY; see Figure 6 | [2] | | | | | | |
| | | V _{CC} = 1.2 V | | - | 11.0 | - | - | - | ns |
| | | V _{CC} = 1.65 V to 1.95 V | | 0.5 | 4.2 | 9.0 | 0.5 | 10.4 | ns |
| | | V_{CC} = 2.3 V to 2.7 V | | 1.0 | 2.5 | 6.9 | 1.0 | 8.0 | ns |
| | | $V_{CC} = 2.7 V$ | | 1.5 | 2.5 | 4.8 | 1.5 | 5.6 | ns |
| | | V_{CC} = 3.0 V to 3.6 V | | 1.0 | 2.3 | 4.1 | 1.0 | 4.8 | ns |
| t _{sk(o)} | output skew time | V_{CC} = 3.0 V to 3.6 V | [3] | - | - | 1.0 | - | 1.5 | ns |
| C _{PD} | power dissipation | per gate; $V_I = GND$ to V_{CC} | <u>[4]</u> | | | | | | |
| | capacitance | V _{CC} = 1.65 V to 1.95 V | | - | 4.4 | - | | | pF |
| | | V_{CC} = 2.3 V to 2.7 V | | - | 7.7 | - | - | - | pF |
| | | $V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$ | | - | 10.5 | - | - | - | pF |

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

- [2] t_{pd} is the same as t_{PLH} and t_{PHL} .
- [3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz, f_o = output frequency in MHz

 C_{L} = output load capacitance in pF

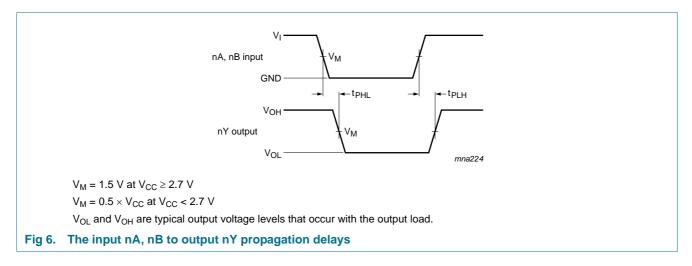
V_{CC} = supply voltage in Volts

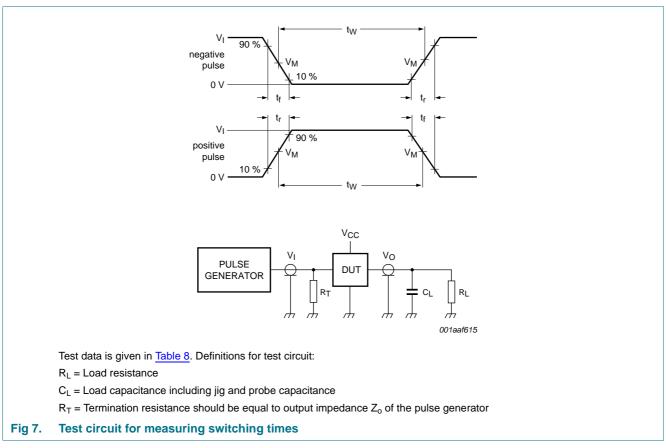
N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

Quad 2-input AND gate

11. AC waveforms





74LVC08A

6 of 15

NXP Semiconductors

74LVC08A

Quad 2-input AND gate

| Supply voltage | Input | | Load | |
|------------------|-----------------|---------------------------------|-------|-------|
| | VI | t _r , t _f | CL | RL |
| 1.2 V | V _{CC} | ≤ 2 ns | 30 pF | 1 kΩ |
| 1.65 V to 1.95 V | V _{CC} | ≤ 2 ns | 30 pF | 1 kΩ |
| 2.3 V to 2.7 V | V _{CC} | \leq 2 ns | 30 pF | 500 Ω |
| 2.7 V | 2.7 V | \leq 2.5 ns | 50 pF | 500 Ω |
| 3.0 V to 3.6 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500 Ω |

Quad 2-input AND gate

12. Package outline

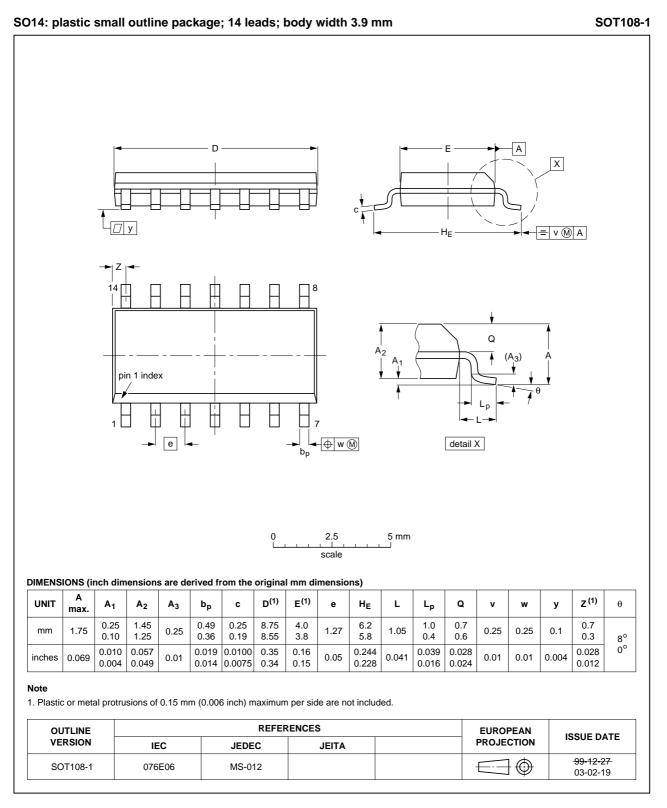
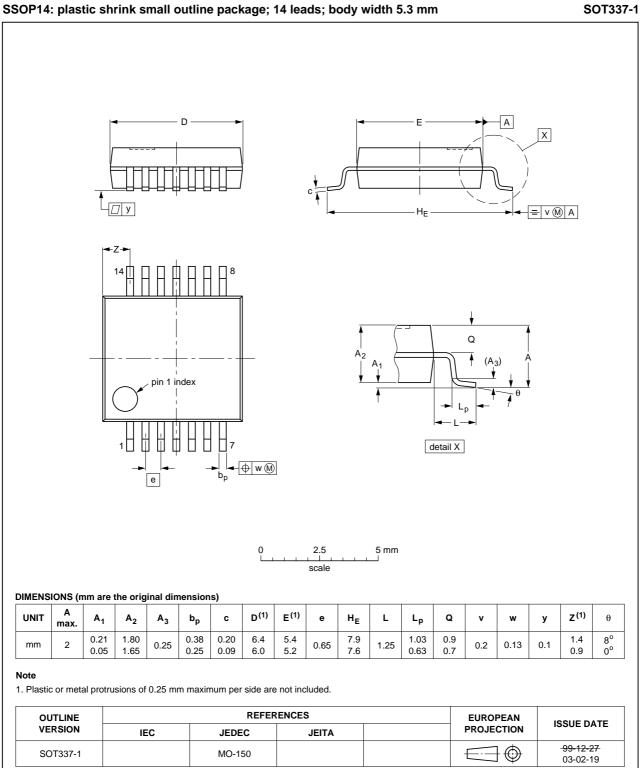


Fig 8. Package outline SOT108-1 (SO14)

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SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

Fig 9. Package outline SOT337-1 (SSOP14)

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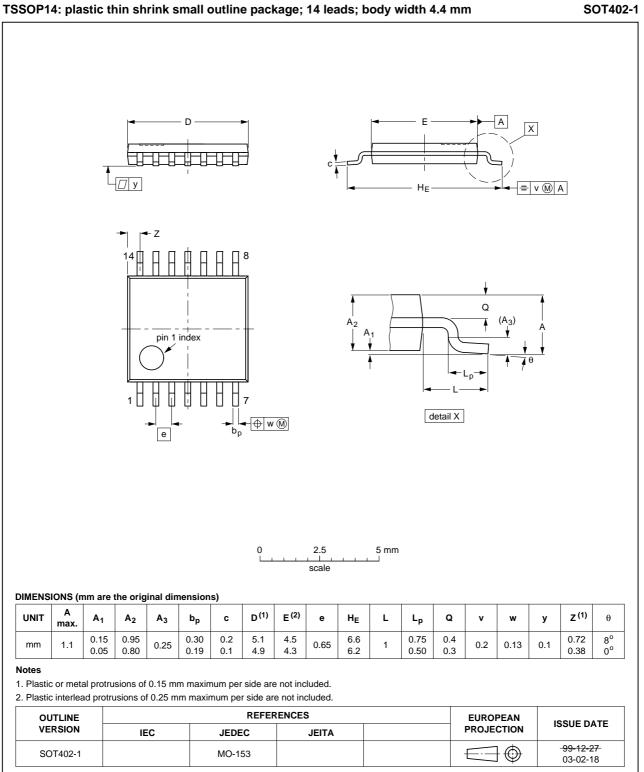
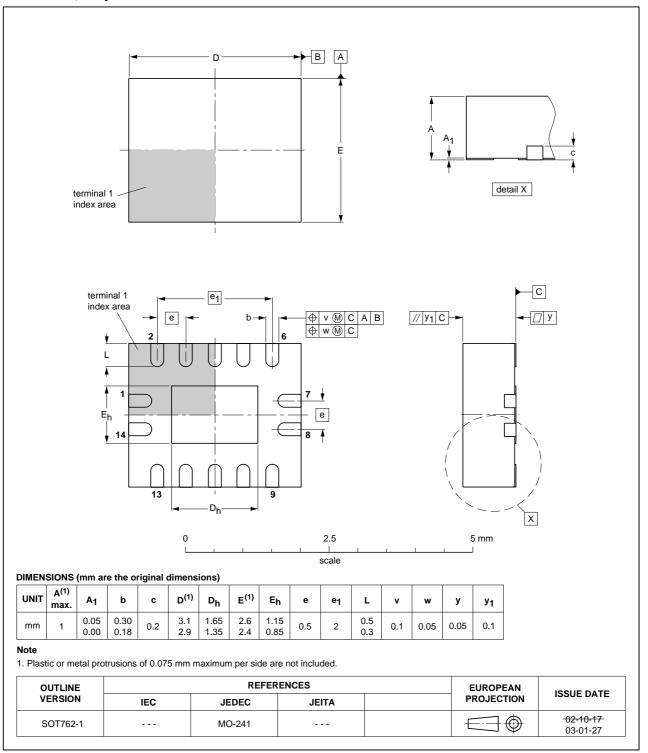


Fig 10. Package outline SOT402-1 (TSSOP14)

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DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm SOT762-1

Fig 11. Package outline SOT762-1 (DHVQFN14)

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74LVC08A

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13. Abbreviations

| Table 9. | Abbreviations |
|----------|-----------------------------|
| Acronym | Description |
| CDM | Charged Device Model |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

14. Revision history

| Table 10. Revision | history | | | |
|--------------------|--|------------------------------|--------------------------|-------------------------------|
| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| 74LVC08A v.6 | 20111216 | Product data sheet | | 74LVC08A v.5 |
| Modifications: | The format of t NXP Semicone | | esigned to comply with t | he new identity guidelines of |
| | Legal texts have | ve been adapted to the new | company name where | appropriate. |
| | • Table 4, Table | 5, Table 6, Table 7 and Tabl | e 8: values added for lo | ower voltage ranges. |
| 74LVC08A v.5 | 20030224 | Product specification | - | 74LVC08A v.4 |
| 74LVC08A v.4 | 20021030 | Product specification | - | 74LVC08A v.3 |
| 74LVC08A v.3 | 20020308 | Product specification | - | 74LVC08A v.2 |
| 74LVC08A v.2 | 19970630 | Product specification | - | 74LVC08A v.1 |
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13 of 15

Quad 2-input AND gate

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17. Contents

| 1 | General description 1 |
|------|------------------------------------|
| 2 | Features and benefits 1 |
| 3 | Ordering information 1 |
| 4 | Functional diagram 2 |
| 5 | Pinning information 2 |
| 5.1 | Pinning 2 |
| 5.2 | Pin description 3 |
| 6 | Functional description 3 |
| 7 | Limiting values 3 |
| 8 | Recommended operating conditions 4 |
| 9 | Static characteristics 4 |
| 10 | Dynamic characteristics 5 |
| 11 | AC waveforms 6 |
| 12 | Package outline 8 |
| 13 | Abbreviations 12 |
| 14 | Revision history 12 |
| 15 | Legal information 13 |
| 15.1 | Data sheet status 13 |
| 15.2 | Definitions 13 |
| 15.3 | Disclaimers |
| 15.4 | Trademarks 14 |
| 16 | Contact information 14 |
| 17 | Contents 15 |

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